

TBB1002

Twin Build in Biasing Circuit MOS FET IC VHF/UHF RF Amplifier

HITACHI

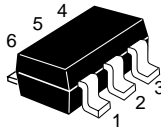
ADE-208-987F (Z)
7th. Edition
Dec. 2000

Features

- Small SMD package CMPAK-6 built in twin BBFET; To reduce using parts cost & PC board space.
- Suitable for World Standard Tuner RF amplifier.
- Very useful for total tuner cost reduction.
- Withstanding to ESD; Build in ESD absorbing diode. Withstand up to 200 V at $C = 200 \text{ pF}$, $R_s = 0$ conditions.
- Provide mini mold packages; CMPAK-6

Outline

CMPAK-6



1. Gate-1(1)
2. Source
3. Drain(1)
4. Drain(2)
5. Gate-2
6. Gate-1(2)

- Notes:
1. Marking is "BM".
 2. TBB1002 is individual type number of HITACHI TWIN BBFET.

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	6	V
Gate1 to source voltage	V_{G1S}	+6 -0	V
Gate2 to source voltage	V_{G2S}	+6 -0	V
Drain current	I_D	30	mA
Channel power dissipation	P_{ch}^{*3}	250	mW
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 3. Value on the glass epoxy board (49mm × 38mm × 1mm).

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

The below specification are applicable for UHF unit (FET1)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	—	—	V	$I_D = 200\mu\text{A}$, $V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	+6	—	—	V	$I_{G1} = +10\mu\text{A}$, $V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	+6	—	—	V	$I_{G2} = +10\mu\text{A}$, $V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I_{G1SS}	—	—	+100	nA	$V_{G1S} = +5\text{V}$, $V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I_{G2SS}	—	—	+100	nA	$V_{G2S} = +5\text{V}$, $V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	$V_{G1S(off)}$	0.5	0.75	1.0	V	$V_{DS} = 5\text{V}$, $V_{G2S} = 4\text{V}$, $I_D = 100\mu\text{A}$
Gate2 to source cutoff voltage	$V_{G2S(off)}$	0.5	0.75	1.0	V	$V_{DS} = 5\text{V}$, $V_{G1S} = 5\text{V}$, $I_D = 100\mu\text{A}$
Drain current	$I_{D(op)}$	13	17	21	mA	$V_{DS} = 5\text{V}$, $V_{G1} = 5\text{V}$ $V_{G2S} = 4\text{V}$, $R_G = 100\text{k}\Omega$
Forward transfer admittance	$ y_{fs} $	21	26	31	mS	$V_{DS} = 5\text{V}$, $V_{G1} = 5\text{V}$, $V_{G2S} = 4\text{V}$ $R_G = 100\text{k}\Omega$, $f = 1\text{kHz}$
Input capacitance	C_{iss}	1.4	1.8	2.2	pF	$V_{DS} = 5\text{V}$, $V_{G1} = 5\text{V}$
Output capacitance	C_{oss}	1.0	1.4	1.8	pF	$V_{G2S} = 4\text{V}$, $R_G = 100\text{k}\Omega$
Reverse transfer capacitance	C_{rss}	—	0.02	0.04	pF	$f = 1\text{MHz}$
Power gain	PG	16	21	—	dB	$V_{DS} = V_{G1} = 5\text{V}$, $V_{G2S} = 4\text{V}$ $R_G = 100\text{k}\Omega$, $f = 900\text{MHz}$ $Z_i = S11^*$, $Z_o = S22^*(\cdot:PG)$
Noise figure	NF	—	1.7	2.5	dB	$Z_i = S11_{opt}$ ($\cdot:NF$)

Electrical Characteristics (Ta = 25°C)

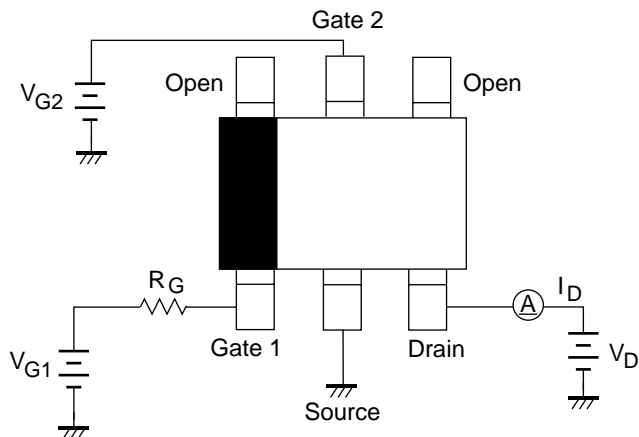
The below specification are applicable for VHF unit (FET2)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	—	—	V	$I_D = 200\mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	+6	—	—	V	$I_{G1} = +10\mu A, V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	+6	—	—	V	$I_{G2} = +10\mu A, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I_{G1SS}	—	—	+100	nA	$V_{G1S} = +5V, V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I_{G2SS}	—	—	+100	nA	$V_{G2S} = +5V, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	$V_{G1S(off)}$	0.5	0.75	1.0	V	$V_{DS} = 5V, V_{G2S} = 4V, I_D = 100\mu A$
Gate2 to source cutoff voltage	$V_{G2S(off)}$	0.5	0.75	1.0	V	$V_{DS} = 5V, V_{G1S} = 5V, I_D = 100\mu A$
Drain current	$I_{D(op)}$	14	18	22	mA	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega$
Forward transfer admittance	$ y_{fs} $	20	25	30	mS	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega, f = 1kHz$
Input capacitance	C_{iss}	2.2	2.6	3.0	pF	$V_{DS} = 5V, V_{G1} = 5V$
Output capacitance	C_{oss}	1.2	1.6	2.0	pF	$V_{G2S} = 4V, R_G = 82k\Omega$
Reverse transfer capacitance	C_{rss}	—	0.03	0.05	pF	$f = 1MHz$
Power gain	PG	22	27	—	dB	$V_{DS} = V_{G1} = 5V, V_{G2S} = 4V$
Noise figure	NF	—	1.2	1.7	dB	$R_G = 82k\Omega, f = 200MHz$

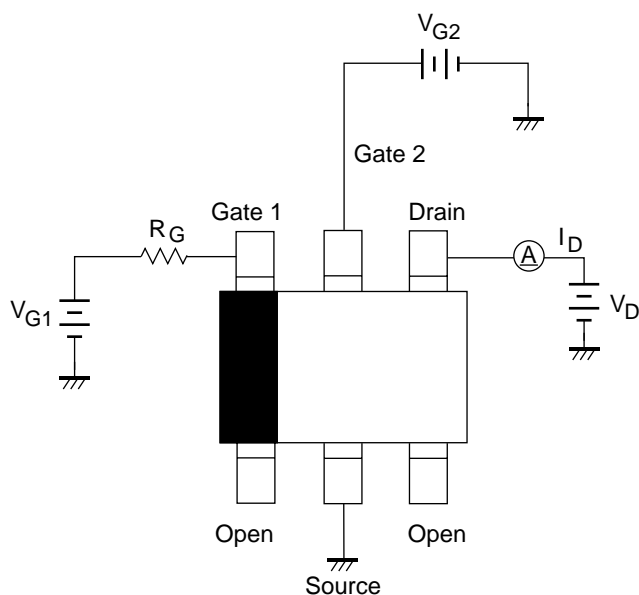
Test Circuits

- DC Biasing Circuit for Operating Characteristic Items ($I_{D(op)}$, $|y_{fs}|$, C_{iss} , C_{oss} , C_{rss} , NF , PG)

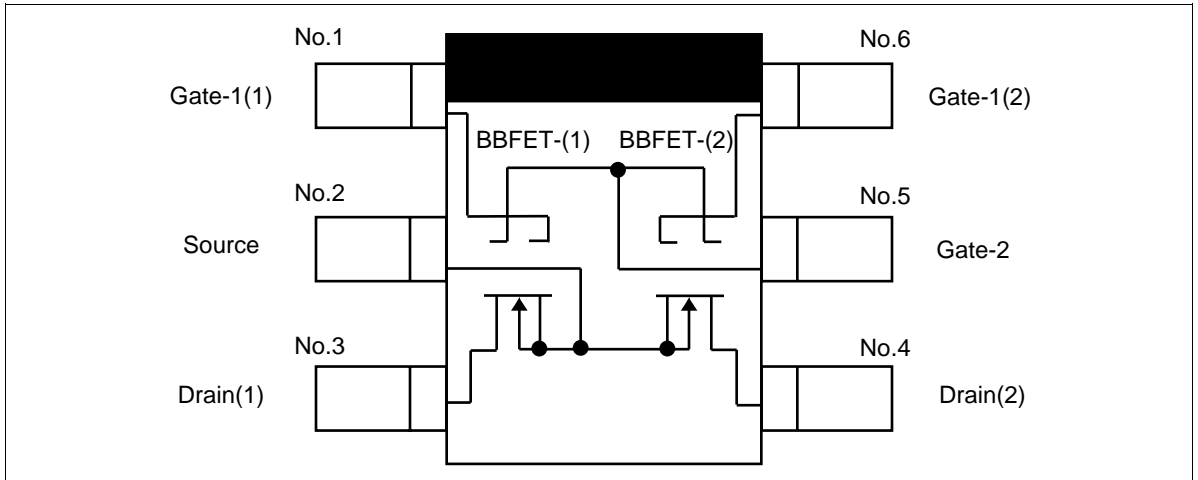
Measurement of FET1



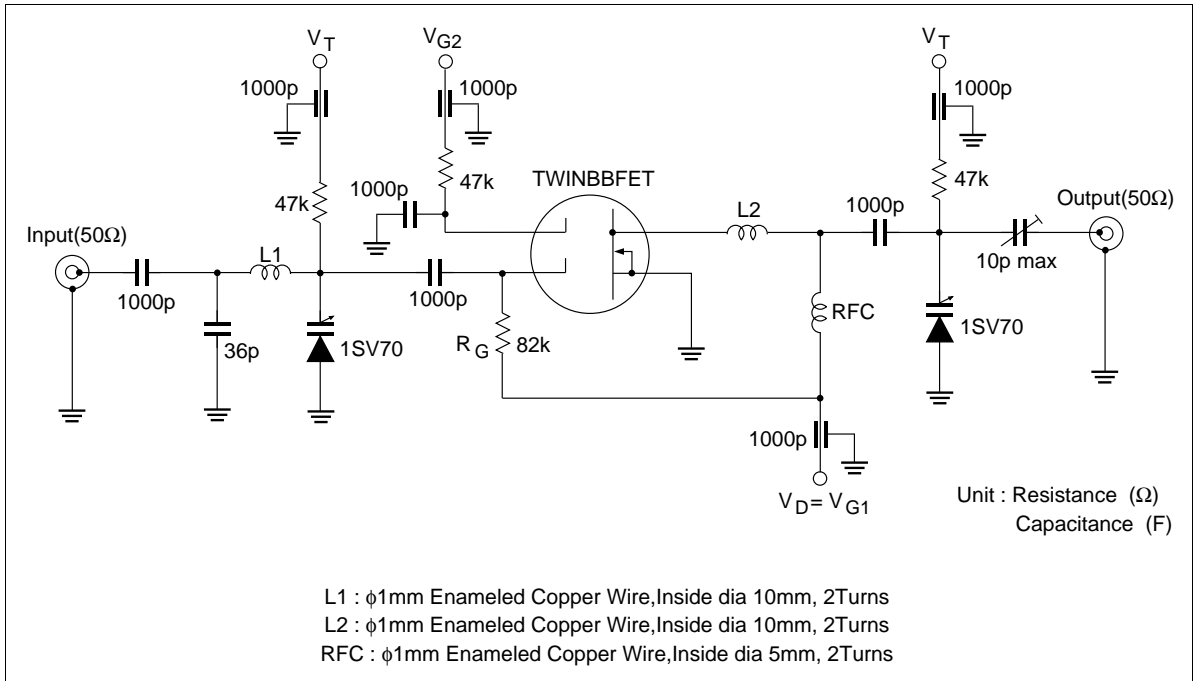
Measurement of FET2



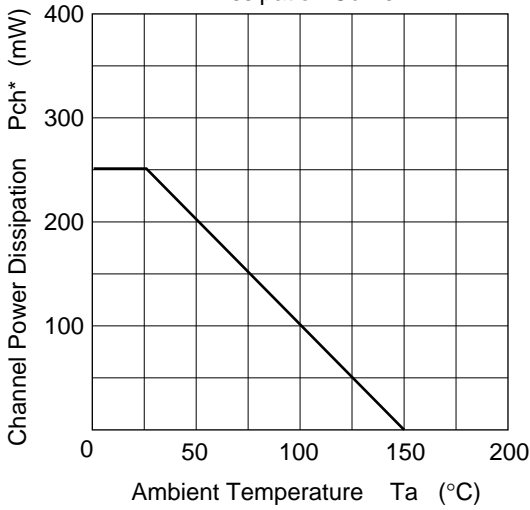
• Equivalent Circuit



• 200 MHz Power Gain, Noise Figure Test Circuit

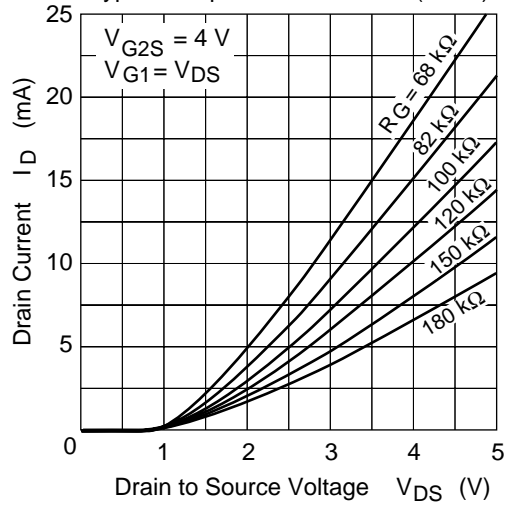


Maximum Channel Power Dissipation Curve

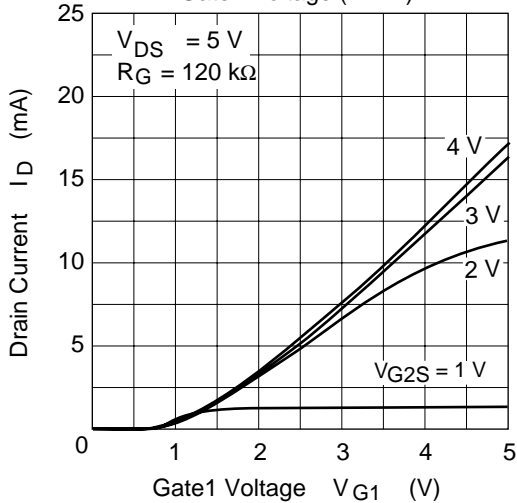


* Value on the glass epoxy board (49mm × 38mm × 1mm)

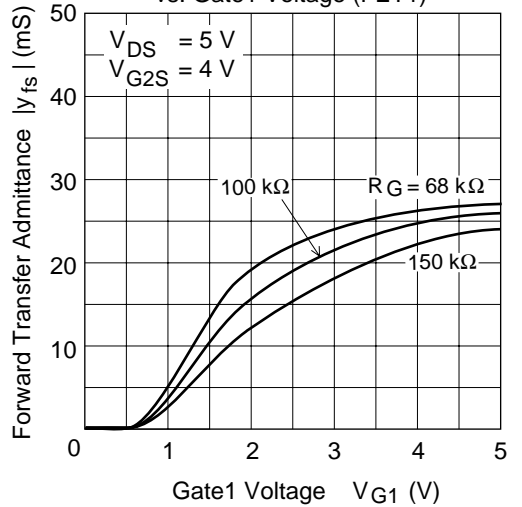
Typical Output Characteristics (FET1)

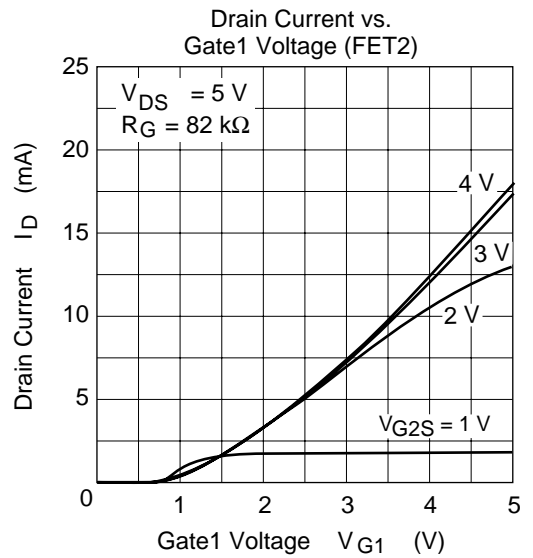
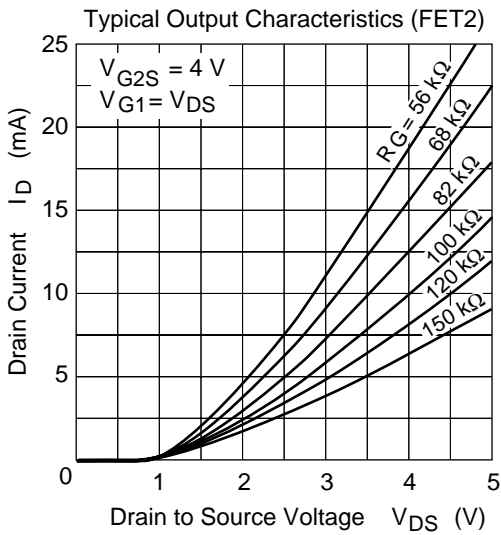
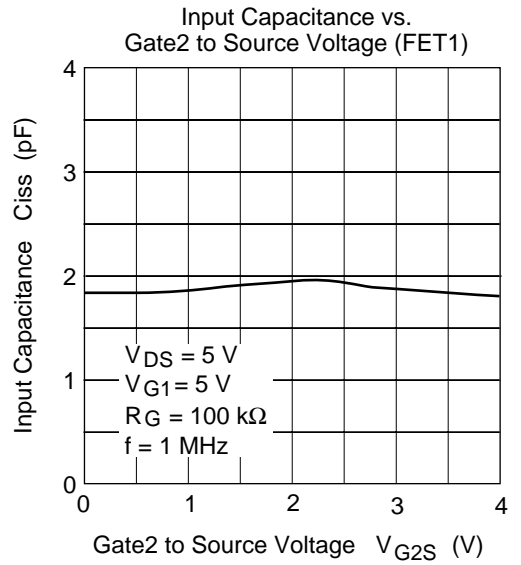
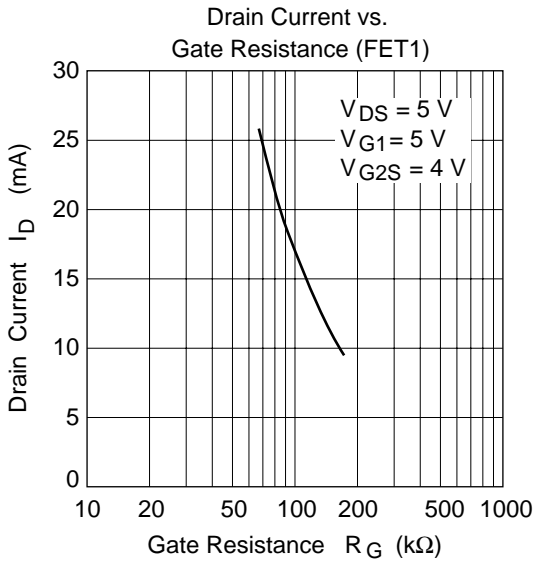


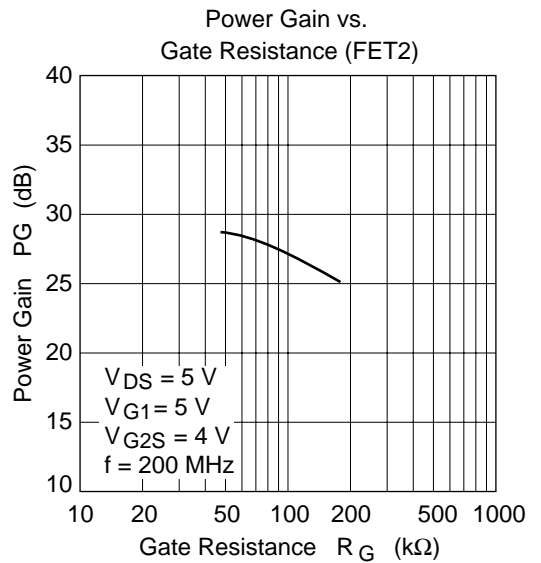
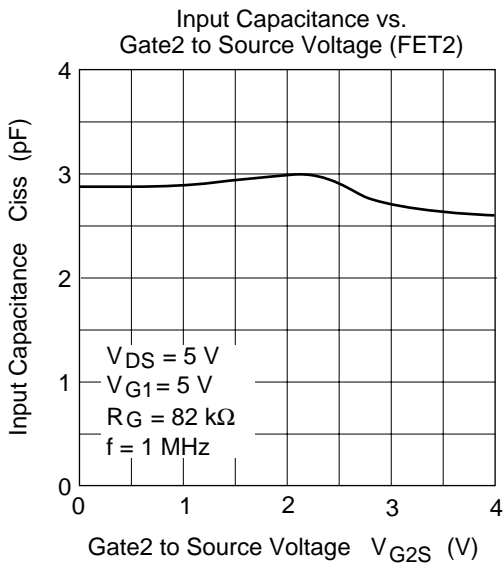
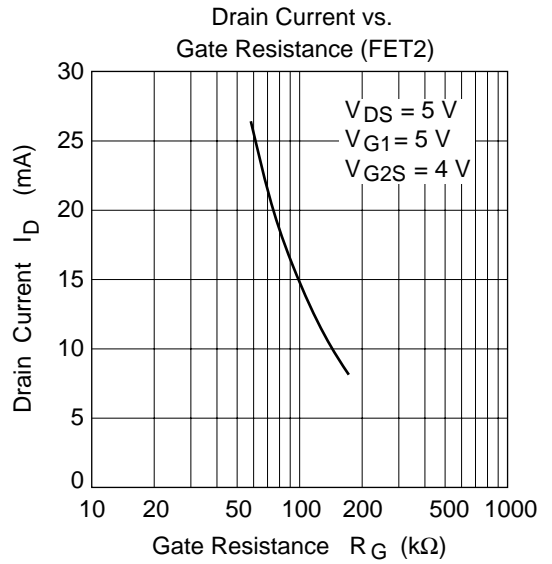
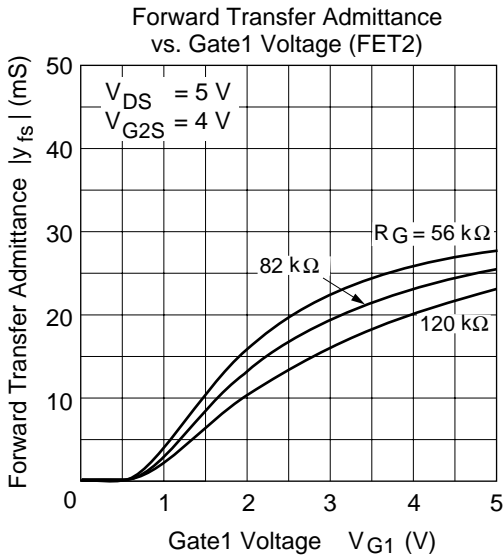
Drain Current vs. Gate1 Voltage (FET1)

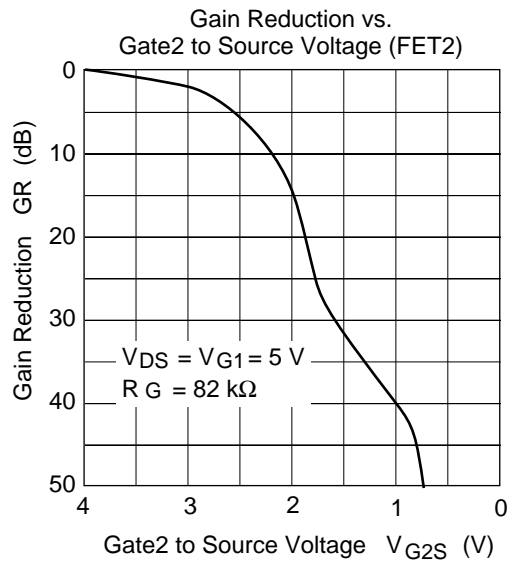
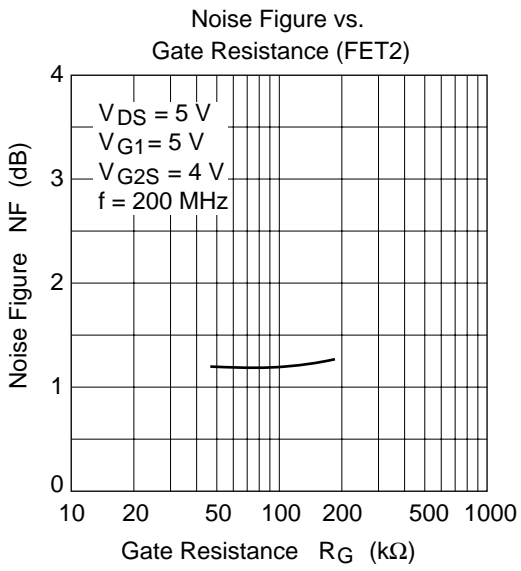


Forward Transfer Admittance vs. Gate1 Voltage (FET1)





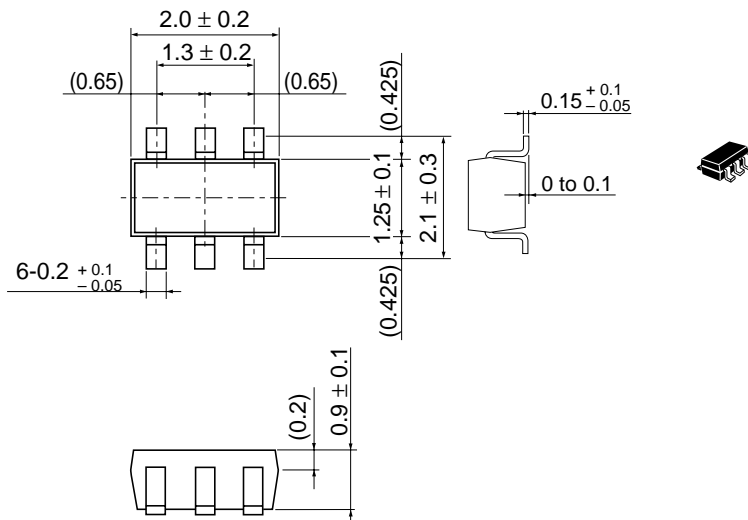




Package Dimensions

As of January, 2001

Unit: mm



Hitachi Code	CMPAK-6
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.006 g

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